

**MOTION CONTROL** 

TMC 363 – DATA SHEET

transformerless VFD Power Supply IC with optional control via 2 wire serial Interface

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## **Features**

GERMANY

The TMC363 is a filament driver for Vacuum Fluorescent Displays (VFD), replacing the commonly used expensive high current transformers. It drives the filament using a sine wave, eliminating the high energy square wave chopper EMV impulses and EMV radiation. This leads to a smarter and much lighter and inexpensive solution. It is realized in a HVCMOS technology combined with Low-RDS-ON high efficiency MOSFETs (pat. fi.). The TMC363 gives the choice to operate at high temperature or at high current of up to 1060 mA. Its low current consumption and high efficiency together with the miniature package make it a perfect solution for battery powered devices as well as weight and dimension critical applications. The device can be controlled by a serial interface (I<sup>2</sup>C-like) or by analog / digital input signals. Temperature and undervoltage protection is integrated.

- Outputs two sine waves with 6 bit resolution
- Two wire serial interface
- Amplitude selectable via resistor or serial interface
- Frequency and offset digitally switchable or programmable via serial interface
- Slope control programmable via single resistor
- Chopper frequency programmable via a single capacitor or external clock range 50kHz to 500kHz
- Integrated soft start
- Step up Converter for VFD Anode supply using external Power MOS (50V; 250mA at >=9V supply)
- 7V to 28.5V supply voltage (up to 38.5V as option)
- Two integrated PWM-controlled half-bridges with up to 1500mA peak output current (1060mA rms) and more than 800mA at 105°C
- Status flags for over temperature, temperature pre-warning, and undervoltage can be read out
- Low power consumption via low RDS-ON power stage
- Shutdown mode available

### Life support policy

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## **Pinning**



Figure 1: Pinning

Package codes

Package	Temperature range	Code/marking
PQFP 44	automotive	TMC363-PA

Table 1: package code

#### +۷<sub>s</sub> optional short detection R<sub>SL</sub> Rove SLP Г TMC363 short prot. Q vs. RC Ļ∘ osc 41 2V REF 5V Reg. Under-voltage 2V <sup>6</sup>/DAC Tem-perature 2 wire serial-Interface SDA Current Controlled Gate Drivers С, - 1 Ŧ Control & Diagnosis SCL 0V 2V RLOAD PWM-CTRL L<sub>2</sub> HE ∾ FUNC0 N С., FUNC1 ۰v Converter Control +VStepUp R<sub>su</sub> 3.15\ ł ή DAC -SNDA +5VOUT Ţ

# Application circuit / block diagram

Figure 2: block diagram

## **Pin functions**

Pin	Function	Pin	Function
VS, VSB	Supply voltage 7 – 28.5V	GNDA	Analog Ground
VREG	Output of internal 5V regulator Internally connected to Chip supply via double bond; 10mA max.	GND, GNDB	Power ground
OSCR	Oscillator Resistor Output (opt: ceramic resonator output)	OSCRC	Oscillator resistor / capacitor input or external clock input (opt: ceramic resonator input)
FB	Voltage Feedback from LC network	FUNC0, FUNC1	Function select pins
SLP	Slope control resistor	OFFS	Setting of sine wave offset
VT	Input of short to GND detector	FS0, FS1, FS2	Setting of sine wave frequency
ENN	Enable (low active), high for low power standby	VAMPL	Setting of sine wave amplitude
SCL	serial data clock	O1, O2	Output of bridge
SDA	serial data line (O.C.)	UPFB	Feedback-Voltage for Step Up- Converter. Tie to +5V if unused.
UPDRV	Driver Transistor output for Step- Up-Converter	TRIG	Trigger output

Table 2: pin functions

## Filament sine wave drive



Figure 3: Filament AC Drive

The potential of the different supply voltages of VF-Displays is shown in figure 3. The filament voltage (Ef) is always higher than the ground potential of the anode and grid voltage (ec, eb) to cut off background illumination. For exemplification the voltage plan of the TMC363 is equivalent to an application with a center tap transformer including a bias voltage.

### Example of use



In standard applications the TMC363 provides a sine wave which amplitude is programmable in the range of 0V up to  $V_S$ -1V. At supply voltages higher than 26V the amplitude is limited to  $26V_{PP}$ . The step-up voltage for the anode or grid supply is not limited to  $V_S$ . The amplitude of the step-up voltage is controlled by the external voltage divider and/or the serial interface value.



Figure 5: Boost sine wave mode

In boost mode its possible to acquire a sine wave amplitude which is higher than the supply voltage. In this case the bridge supply ( $V_{SB}$ ) has to be connected to the output of the step-up converter. The sine wave amplitude is than limited to 1V below the step-up voltage but at most up to  $26V_{PP}$ . Caution: The maximum bridge supply voltage is 40V (see absolut maximum ratings). A higher voltage can damage the device.

## **Function setting**

Func1	Func0	mode
0	0	reserved (do not use)
0	1	serial interface mode
1	0	sinus wave (stand alone mode)
1	1	DC output (stand alone mode)

## Table 3: function settings

The function of the TMC363 is selectable via the 'Func' pins. In serial interface mode the option between sine wave or dc voltage is selectable.

## **Frequency setting**

The PWM oscillator frequency can be set by an external capacitor and an external resistor. The internal oscillator uses the resistor to charge / discharge the capacitor to a trip voltage of 2/3 Vcc respectively 1/3 Vcc. It can be overdriven using an external CMOS level square wave signal.

The TMC363 uses  $f_{\text{OSC}}$  / 16 as chopper frequency. This chopper frequency is used for the sine wave and the step up converter.

$$f_{chop} = \frac{f_{osc}}{16}$$

Table of frequencies when set via the pins. All values can be selected via serial interface.

f <sub>sin</sub> divider	f <sub>sin</sub> @ 8 MHz f <sub>OSC</sub>	f <sub>sin</sub> @ 6 MHz f <sub>OSC</sub>	f <sub>sin</sub> @ 4 MHz f <sub>OSC</sub>	FS2	FS1	FS0
/ 80000	100 Hz	75 Hz	50 Hz	0	0	0
/ 20000	400 Hz	300 Hz	200 Hz	0	0	1
/ 444	18.0 kHz	13.5 kHz	9.0 kHz	0	1	0
/ 256	31.3 kHz	23.5 kHz	15.6 kHz	0	1	1
/ 186	43.0 kHz	32.3 kHz	21.5 kHz	1	0	0
/ 144	55.6 kHz	41.7 kHz	27.8 kHz	1	0	1
/ 116	69.0 kHz	51.8 kHz	34.5 kHz	1	1	0
/ 100	80.0 kHz	60.0 kHz	40.0 kHz	1	1	1

**Table 4: frequency settings** 

The dimension of the output filter (LC-Combination) is depending on the frequency. At frequencies greater then  $f_{OSC}/160$  the filter needs to be at least 2<sup>nd</sup> order.

### Oscillator

The PWM oscillator frequency can be set by an external capacitor and an external resistor. The internal oscillator charges / discharges the capacitor between the trip voltages.

Alternatively a 2.5  $\dots$  8-MHz ceramic resonator (with load capacitors C<sub>L</sub>) can be used.

The oscillator input OSCRC can be overdriven using an external CMOS level square-wave signal.

f <sub>osc</sub> typ	C∟
2.5 MHz	36 pF
4.0 MHz	22 pF
8.0 MHz	15 pF

Table 5: oscillator frequencies when using ceramic resonator

f <sub>osc</sub> typ	R <sub>osc</sub>	C <sub>osc</sub>
2.4 MHz	kΩ	pF
3.1 MHz	kΩ	pF
4.0 MHz	kΩ	pF
5.1 MHz	kΩ	pF
8.0 MHz	kΩ	pF
8.0 MHz	kΩ	pF

Table 6: oscillator frequencies when using RC option

Symbol	Parameter	Condition s	Min	Тур	Max	Unit
f <sub>osc</sub>	frequency of RC-oscillator with defined R and C for 4 MHz	R= kΩ C= 22pF	tbd	4	tbd	MHz

Table 7: oscillator characteristic

Please remark, that an unnecessary high frequency leads to higher switching losses in the power transistors.

#### Serial interface

Communication between a host and the TMC363 takes places via the two wire bi-directional serial interface. The serial interface facilitates the alternative programming of all settings. The frequency is programmable with a resolution of 15 Bit and a range from 0 to 125kHz. The resolution of the amplitude is 6 Bit. Further the offset- and the softstart- option is selectable via the serial interface.

### Output voltage swing

The output voltage setting is controlled by a resistive divider. Depending on the offset setting and on the actual load, the lower sine wave limit varies between 0 and 2V. The upper limit can be set up to 21V. The output voltage of the TMC363 is equal to:

$$V_{FB_{max}} = 4.2 \cdot V_{Ampl} \frac{n}{63}$$

whereas n is depending on the operational mode. In stand alone mode the value of n is 63. In the serial interface mode n is selectable in the range 0 to 63.

The accuracy of the filament output depends on the selected output frequency. The control logic analyze the output via a few full periods to avert output swing. At a supply voltage jump of 10% the control time of 50Hz sine wave setting amounts at most 100ms. At frequencies greater than 10kHz the control time shrinks to a value below 100µs.

#### Undervoltage detection

The internal circuitry starts operation, whenever the 5V supply is in its lower operation limit. Because the required supply voltage depends on the required filament voltage, the internal circuit monitors the output to determine if it can reach the filament voltage level set by the user.

#### Step up converter

The step up converter monitors the output voltage. Chopping frequency is fixed to 1/16 oscillator frequency. When the output voltage is below the comparator threshold, the transistor duty cycle is increased from 0/16 to 10/16 within 10 oscillator cycles. It is reduced down to zero in 10 cycles if the voltage is continuously above the threshold. The maximum duty cycle is programmable via the serial interface. The standard setting for the maximum duty cycle is 10/16 and is increasable to 12/16 for higher current request.

The output voltage is set by the voltage divider  $R_{SU1}$  and  $R_{SU2}$ .

$$V_{Step\_Up} = V_{UPFB} \left( \frac{R_{SU1}}{R_{SU2}} + 1 \right)$$

The value of  $V_{UPFB}$  is fix at 3.15V. In serial interface mode this voltage is regulated by the configuration of the DAC2 parameter.

$$V_{UPFB} = 3.15V \frac{n}{63}$$

n is the value of DAC2\_0 ... DAC2\_5.

## Slope control resistor

The output-voltage slope of the full bridge outputs can be controlled to reduce noise on the power supply and on the filament and thus electromagnetic emission of the circuit. It is controlled by an external resistor at the SLP pin.

Operational range:

 $12.5k\Omega \leq R_{SLP} \leq 150k\Omega$ 

Please remark, that there is a trade off between reduced electromagnetic emissions (slow slope) and high efficiency because of low dynamic losses (fast slope).

## Example for slope settings

t <sub>sLP</sub> typ.	R <sub>SLP</sub>
30ns	KΩ
	KΩ
	KΩ
	KΩ
300ns	KΩ

Table 8: slope settings

## **Absolute Maximum Ratings**

The maximum ratings may not be exceeded under any circumstances. 40V transistor version is assumed.

Symbol	Parameter		Min	Мах	Unit
Vs	Supply voltage (core chip)			40	V
V <sub>T</sub>	Short-to-Ground Detector Input Voltage		V <sub>S</sub> + 1V	V <sub>S</sub> +0.3V	V
$V_{FB}$	Feedback Input Voltage		-0.3	V <sub>S</sub> +0.3V	V
$V_{BR}$	Bridge voltage V <sub>SB</sub> -V <sub>GNDB</sub>			40	V
$V_{MD}$	Supply and bridge voltage / device disabled max. 20000s			tbd	V
$V_{\text{TRL}}$	Lower side power transistor voltage $V_{\text{O1}}\text{-}V_{\text{GNDB}}, V_{\text{O1}}\text{-}V_{\text{GNDB}}$			40	V
$V_{\text{TRH}}$	Upper side power transistor voltage $V_{SB}$ - $V_{O1}$ , $V_{SB}$ - $V_{O1}$			40	V
$V_{DD}$	Logic supply voltage (*: internally regulated)			6(*)	V
I <sub>OP</sub>	Output peak current (short pulse)			6	А
I <sub>oc</sub>	Output current	$T_A \le 85^\circ C$		1500	mA
	(continuous, one bridge)	$T_A \le 105^\circ C$		1000	
		$T_A \le 125^\circ C$		800	
V <sub>ID</sub>	Logic input voltage		-0.3	V <sub>DD</sub> +0.3V	V
VIA	Analog Input Voltage		-0.3	V <sub>DD</sub> +0.3V	V
$T_J$	Junction temperature		-40	150	°C
T <sub>STG</sub>	Storage temperature		-55	150	°C

Table 9: absolut maximum ratings

## **Electrical Characteristics**

## **Operational Range**

Symbol	Parameter	Min	Max	Unit
T <sub>AI</sub>	Ambient temperature industrial (1)	-25	125	°C
T <sub>AA</sub>	Ambient temperature automotive	-40	125	°C
ΤJ	Junction temperature	-40	140	°C
Vs	Bridge supply voltage (2)	7	38.5	V
f <sub>CLK</sub>	Oscillator clock frequency	0	8	MHz
f <sub>Chop</sub>	Chopper clock frequency		500	kHz
$R_{SLP}$	Slope control resistor	12.5	150	KΩ

Table 10: operational range

- (1) The circuit can be operated up to 140°C, but output power derates.
- (2) The maximum operating supply voltage is reduced from 40V to 38.5V with inductive loads, because inductive loads increase the output voltage above / below the supply voltage rail in fast decay and change of polarity situations.

## **DC Characteristics**

DC characteristics contain the spread of values guaranteed within the specified supply voltage and temperature range unless otherwise specified. Typical characteristics represent the average value of all parts.

Junction temperature:  $T_J = -40^{\circ}C \dots 150^{\circ}C$ , Bridge supply voltage :  $V_S = 7 V \dots 38.5 V$ (unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{OUT,Sink}}$	R <sub>DSON</sub> of sink-transistor	$\begin{array}{l} T_{A} = 25^{\circ}C \\ V_{S} \geq 8V \end{array}$		0.10	0.12	Ω
R <sub>OUT,Source</sub>	R <sub>DSON</sub> of source-transistor	$\begin{array}{l} T_{A} \texttt{=} \texttt{25}^{\circ}C \\ V_{S} \geq 8V \end{array}$		0.20	0.24	Ω
$R_{\text{OUT,Sink}}$	R <sub>DSON</sub> of sink-transistor max.	$\begin{array}{l} T_{\text{J}} = 150 \ ^{\circ}\text{C} \\ V_{\text{S}} \geq 8 V \end{array}$		0.17	0.20	Ω
R <sub>OUT,Source</sub>	R <sub>DSON</sub> of source-transistor max.	$\begin{array}{l} T_{\text{J}} = 150 \ ^{\circ}\text{C} \\ V_{\text{S}} \geq 8 V \end{array}$		0.34	0.41	Ω
V <sub>DIO</sub>	Diode forward voltages of O <sub>xx</sub> MOSFET diodes	$T_{\rm J} = 25^{\circ}C$ $I_{\rm OXX} = 1.05A$		0.82	1.10	V
V <sub>IH</sub>	High input voltage (all digital inputs)		2.2		VCC + 0.3 V	V
V <sub>IL</sub>	Low input voltage (all digital inputs)		-0.3		0.7	V
V <sub>IHYS</sub>	Input voltage hysteresis (all digital inputs)		100	250	500	mV
V <sub>OH</sub>	High output voltage (output SDO)	-I <sub>OH</sub> = 1mA	VCC - 0.6	VCC - 0.2	VCC	V
V <sub>OL</sub>	Low output voltage (output SDO)	I <sub>OL</sub> = 1mA	0	0.2	0.4	V
V <sub>UPFB</sub>	Step up feedback voltage			3.15	3.32	V
-I <sub>ISL</sub>	Low input current (all digital inputs)	$V_1 = 0$ $V_{CC} = 3.3V$ $V_{CC} = 5.0V$	2	10 25	70	μΑ μΑ μΑ
-I <sub>IEL</sub>	Low input current (input ENN)	$V_1 = 0$ $V_{CC} = 3.3V$ $V_{CC} = 5.0V$	10	20 30	50	μΑ μΑ μΑ

Table 11: dc characteristics

## **Thermal Protection**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>JOT</sub>	Thermal shutdown		145	150	155	°C
T <sub>JOTHYS</sub>	Thermal hysteresis			10		°C
T <sub>JWT</sub>	Prewarning temperature		135	140	145	°C

Table 12: thermal characteristics

## **Two-Wire Serial Interface**

#### **Physical Layer**

Both SDA and SCL lines are connected to positive supply voltage via a current source or pull-up resistor (Figure 6: Physical Layer). When there is no traffic on the bus both lines are high. Analog glitch filters are implemented to suppress spikes with a length up to 50 ns.



Figure 6: Physical Layer

#### **Communication on Two Wire Serial Bus Interface**

Each datagram starts with an Start condition and ends with an Stop condition. Both conditions are unique and cannot confused with data. A high to low transition on the SDA line while SCL is high indicates a Start condition. A low to high transition on the SDA line while SCL is high defines a Stop condition. (Figure 7: Start / Stop Conditions)



Figure 7: Start / Stop Conditions

The SCL clock is always generated by the master. On every rising transition of the SCL line the data on SDA is valid. Data on SDA line is only allowed to change as long as SCL is low. (Figure 8: Bit transfer on Two Wire Serial Bus Interface)



Figure 8: Bit transfer on Two Wire Serial Bus Interface

Every byte put on the SDA line must have a length of 8 bits, where the most significant bit (MSB) is transferred first. The number of bytes that can be transmitted to the TCM363 is restricted to 4 bytes. Each byte is followed by an acknowledge bit, which is issued by the receiving node. (Figure 9: Data Transfer on Two Wire Serial Bus Interface)



Figure 9: Data Transfer on Two Wire Serial Bus Interface

### **Physical Address of the circuit**

The circuit must be provided with a physical address in order to discriminate this circuit from other ones on the serial bus (pins SDA and SCK). This address is coded on 7 bits (1 bits is hardwired to '1' and 2 bits are hardwired to '0'), yielding the theoretical possibility of 16 different circuits on the same bus. It is a combination of the 4 hardwired address bits (pins OFFS, FS[2-0]). (Figure 10: Two Wire Serial Interface - Physical Address)

The TCM363 supports a "general call" address. Therefore the circuit is addressable with either the physical slave or with address "000 0000".

AD6	AD5	AD4	AD3	AD2	AD1	AD0	Physical address
'1'	'0'	'0'	OFFS	FS2	FS1	FS0	Hardwired Bit (connect to 0 or 1)

Figure 10: Two Wire Serial Interface - Physical Address

#### Write data to TMC363

A complete datagram consists of the following: a Start condition, 5 data bytes and a stop condition. Each data byte is followed by an acknowledge bit. The acknowledge bit is used to signal the transmitter of the data byte the correct reception of the data, in this case the TMC363 pulls the SDA line to zero. (Figure 11: Two Wire Serial Interface - Writing Data to Slave).

The first data byte consists of the slave address (7 bit) and a read/write bit ('0' = write, '1' = read). The other 4 bytes contains the configuration settings of the TMC363.

The TMC363 reads the incoming data at SDA with every rising edge on the SCL line. To finish the transmission the master has to transmit a Stop condition.

S Stave addr	A		////// A			A	Þ
'0' (V	∟ Vrite)	(n	Bytes +	acknowledge)	)		I
master to slave	S: Start ( P: Stop ( <u>A:</u> Ackno A: not Ac	Condition Condition owledge (S cknowledge	DA low) e (SDA h	igh)			

Figure 11: Two Wire Serial Interface - Writing Data to Slave

#### Read data from TMC363

When reading data from a slave only one datagram is needed. The datagram consists of one data byte that consists of the slave address (7 bit) and the read bit ('1').

Then the master can read the data byte on the SDA line with every rising edge on the SCL line. After the byte of data the master has to acknowledge correct data reception by pulling SDA to zero. The last byte is not to acknowledge by the master and therefore the slave knows the end of transmission. (Figure 12: Two Wire Serial Interface - Read Data from Slave)

### Read Data from Slave



Figure 12: Two Wire Serial Interface - Read Data from Slave

#### Timing characteristics of the serial interface



#### Figure 13: Definition of Timing

Paramotor	Symbol	SCL Clk freque	ency <= 100KHz	SCL Clk freque	Unit	
r al allietei	Symbol	Min.	Max.	Min.	Max.	Unit
Low level input voltage: Fixed input levels	VIL	-0.5 <sup>(1)</sup>	1.5	-0.5 <sup>(1)</sup>	0.3V <sub>DD</sub>	V
High level input voltage: Fixed input levels	VIH	3.0	(2)	$0.7V_{DD}$	(2)	V
Pulse width of spikes which must be suppressed by the input filter	t <sub>SP</sub>	n/a	n/a	50	50	Ns
Capacitance for each I/O pin	Ci	-	10	-	10	pF

Table 13: Two Wire Serial Interface - Characteristics of the SDA and SCL I/O Stages

#### Notes

(1): If Input voltage = < -0.3 Volts, then 20...100 Ohms resistor must be added in series

(2): Maximum  $V_{IH} = V_{DDmax} + 0.5$  Volt n/a: not applicable

SCL Clk frequency <= 100KHz SCL Clk frequency <= 350KHz Unit Parameter Symbol Min. Max. Min. Max. KHz SCL clock frequency 100 f<sub>SCL</sub> 0 0 350 Hold time (repeated) START condition. After this period, the first 4.0 0.6 \_ \_ μs t<sub>HD;STA</sub> clock pulse is generated. 1.3 LOW period of the SCL clock 4.7 μs t<sub>LOW</sub> HIGH period of the SCL clock 4.0 0.6 μs t<sub>HIGH</sub> Set-up time for a repeated START 4.7 \_ 0.6 \_ μs t<sub>SU:STA</sub> condition Data set-up time t<sub>su;dat</sub> 250 100 ns Rise time of both SDA and SCL 20+0.1C<sub>b</sub><sup>(1)</sup> 1000 300 ns t, signals Fall time of both SDA and SCL  $20+0.1C_{b}^{(1)}$ tf -300 300 ns signals Set-up time for STOP condition 4.0 0.6 t<sub>su;sto</sub> μs \_ \_ Bus free time between a STOP 4.7 t<sub>BUF</sub> -1.3 μs and START condition  $C_{b}$ 0 400 400 pF Capacitive load for each bus line \_ Noise margin at the LOW level for V each connected device (including  $V_{nL}$  $0.1V_{\text{DD}}$ - $0.1V_{\text{DD}}$ \_ hysteresis) Noise margin at the HIGH level for  $0.2V_{\text{DD}}$ V each connected device (including  $V_{nH}$  $0.2V_{\text{DD}}$ \_ \_ hysteresis)

Table 14: Two Wire Serial Interface - Characteristics of the SDA and SCL bus lines

#### Notes

(1):  $C_b$  = total capacitance of one bus line in pF.

## **Command Description**

Communications between the TMC363 and a Two Wire Serial Bus Interface Master takes place via different commands.

Writing commands are used to:

- Program parameters of sine wave output (frequency, amplitude, softstart and offset)
- select between sine wave- and dc-output voltage
- Configure the amplitude of the step-up converter

Reading commands are used to:

- Get actual status of diagnostic flags
- Get actual status of amplitude amplification

	write command										
Byte	Content		Structure								
		bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0		
0	Slave Address	1	0	0	OFFS Pin	FS2 Pin	FS1 <sub>Pin</sub>	FS0 <sub>Pin</sub>	0		
1	config number	0	0	0	0	0	0	cnfg_1	cnfg_0		
2	Config_0	Output	f_set_14	f_set_13	f_set_12	f_set_11	f_set_10	f_set_9	f_set_8		
3	Config_1	f_set_7	f_set_6	f_set_5	f_set_4	f_set_3	f_set_2	f_set_1	f_set_0		
4	Config_2	Offs_set	softstart	DAC1_5	DAC1_4	DAC1_3	DAC1_2	DAC1_1	DAC1_0		
5	Config_3		STU <sub>max</sub>	DAC2_5	DAC2_4	DAC2_3	DAC2_2	DAC2_1	DAC2_0		

Table 15: write command

- cnfg: The bits 'cnfg\_0 ... cnfg\_1' appoints the config byte which is write first in the registers. Thus its possible to change one parameter by writing only one config byte instead of all config bytes. The start setup demands the configuration of all config bytes. In this case the write command consist of five bytes (config number = 0; config\_0 ... config\_3 = see table 3). If its necessary to change only one parameter (e.g. amplitude of step-up converter) you have to write only two bytes (config number = 3; config\_3 = see table 3).
- Output: Output mode of the TMC363. Set this bit to '0' for sinus wave output. For dc voltage output set this bit to '1'.
- f\_set:

$$f_{\rm sin} = \frac{f_{osc}}{2.097 * 10^6} * f_{sec}$$

This value will not be considered in DC-mode.

- Offs\_set: Offset setting of the sine wave ('0' no offst; '1' 2V offset).
- softstart: The soft start option is active when the bit 'softstart' is set to '1'. In this case the sine wave needs 250ms (at 8MHz  $f_{osc}$ ) to reach the full amplitude. This time shrinks to 10ms by disabling the soft start mode.
- DAC1: The amplitude of the sine wave is set by the bits 'DAC1\_0 ... DAC1\_5'. If all bits are set to '1' the maximum amplitude (21V) is selected. Each bit correspond to 21V / 64. DAC1\_5 is the MSB. The sine wave maximum peak value is calculate by the following formula:

$$V_{FB_{max}} = 4.2 \cdot V_{Ampl} \frac{n}{63}$$

n is the value of DAC1\_0 ... DAC1\_5.

The maximum amplitude is limited by the supply voltage VSB ( $U_{sin limit} = U_{VSB} - 1V$ ).

- STU<sub>max</sub>: The STU<sub>max</sub>-bit limits the maximum duty cycle of the step-up pwm. '0': maximum duty cycle = 62% on (10/16) '1': maximum duty cycle = 75% on (12/16)
- DAC2: The amplitude of the step-up converter is set by the bits 'DAC2\_0 ... DAC2\_5'. Each bit correspond to:

$$V_{LSB} = \frac{\left(\frac{R_{SU1}}{R_{SU2}} + 1\right) V_{\text{Re}f}}{64}$$

	read command										
Byte Content Structure											
	[	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0		
0	Slave Address	1	0	0	OFFS Pin	FS2 <sub>Pin</sub>	FS1 <sub>Pin</sub>	FS0 <sub>Pin</sub>	1		

Table 16: read command

If this command is send from the master, the TMC363 will send two data bytes.

data byte from TMC363 in sine wave mode											
bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0				
	RES_FLG OTPW OT SHORT										
Ampl_7 Ampl_6 Ampl_5 Ampl_4 Ampl_3 Ampl_2 Ampl_1 Ampl_0											

Table 5: read data byte in sine wave mode

RES\_FLG: Status bit of reset flag

- OTPW: Status bit of over temperature pre warning
- OT: Status bit of over temperature
- SHORT: Status bit of short circuit
- Ampl: This byte corresponds to the control value of the sine wave amplitude. If this value is nearly the maximum (0xFF), the supply voltage (VSB) is too low for the selected amplitude.

### **DC Motor Driver Mode**

The TMC363 can be set in DC motor driver mode with the FUNCSEL-pins. If both FUNCSEL-pins are connected to GND then DC motor driver mode is active.

	write command in DC-mode										
Byte	Content		Structure								
		bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0		
0	Slave Address	1	0	0	OFFS Pin	FS2 Pin	FS1 <sub>Pin</sub>	FS0 <sub>Pin</sub>	0		
1	config number	0	0	0	0	0	0	cnfg_1	cnfg_0		
2	DC_Config_0	DIR	SD	CT_1	CT_0	PWM_11	PWM_10	PWM_9	PWM_8		
3	DC_Config_1	PWM_7	PWM_6	PWM_5	PWM_4	PWM_3	PWM_2	PWM_1	PWM_0		
4	DC_Config_2	0	0	0	0	Test_3	Test_2	Test_1	Test_0		

Table 17: write command

- DIR: Direction of DC motor rotation ('0' bridge 2 enable; '1' bridge 1 enable)
- SD: Slow decay mode ('0' normal mode; '1' slow decay active).
- CT: Divider for DC-driver chopper frequency '00':  $f_{DC-chop} = f_{osc} / 256$ '01':  $f_{DC-chop} = f_{osc} / 512$ '10':  $f_{DC-chop} = f_{osc} / 1024$
- PWM: '00...00': DC voltage is off '11...11': DC voltage is maximum
- TEST: Address for test multiplexer '0000': Trigger Output '0001': Bandgap reference '0010': 2V reference '0011': Temp. sense diodes '0100': DAC out '0101': Temperature pre warning '0110': Overtemperature '0111': CMP1 '1000': CMP2 '1001': CMP3 '1010': Short to Ground Detection '1011': GP1 '1100': GP2 '1101': GN1 '1110': GN2
  - '1111': Vs under voltage comparator

cnfg: The bits 'cnfg\_0 ... cnfg\_1' appoints the config byte which is write first in the registers. Thus its possible to change one parameter by writing only one config byte instead of all config bytes. The start setup demands the configuration of all config bytes. In this case the write command consist of four bytes (config number = 0; config\_0 ... config\_2 = see table 5). If its necessary to change only one parameter (e.g. direction of rotation) you have to write only two bytes (config number = 0; config\_0 = see table 3).

read command in DC-mode										
Byte	Content				Stru	cture				
		bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	
0	Slave Address	1	0	0	OFFS Pin	FS2 <sub>Pin</sub>	FS1 <sub>Pin</sub>	FS0 <sub>Pin</sub>	1	

## Table 18: read command

If this command is send from the master, the TMC363 will send one data byte that includes several status bits.

data byte from TMC363 in DC motor driver mode											
bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0				
FUNC_SEL RES_FLG OTPW OT SHORT											

Table 19: read data byte in DC motor driver mode

FUNC\_SEL: Status bit of function selection

RES\_FLG: Status bit of reset flag

- OTPW: Status bit of over temperature pre warning
- OT: Status bit of over temperature
- SHORT: Status bit of short circuit

## ESD protection

Please be aware, that the TMC363 is an ESD sensitive device due to integrated high performance MOS transistors.



ESD sensitive device

If the ICs are manually handled before / during soldering, special precautions have to be taken to avoid ESD voltages above 100V HBM (Human body model). For automated SMD equipment the internal device protection is specified with 1000V CDM (charged device model), tbf.

When soldered to the application board, all inputs and outputs withstand at least 1000V HBM.